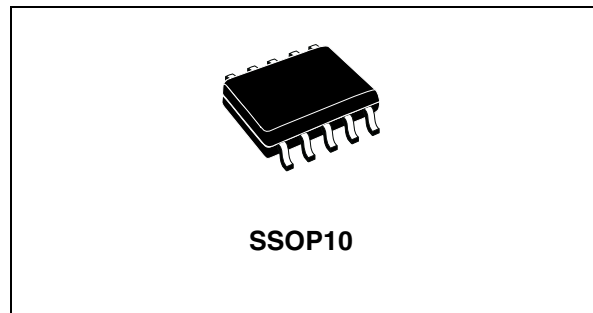


## 10-pin transition-mode PFC controller

### Features

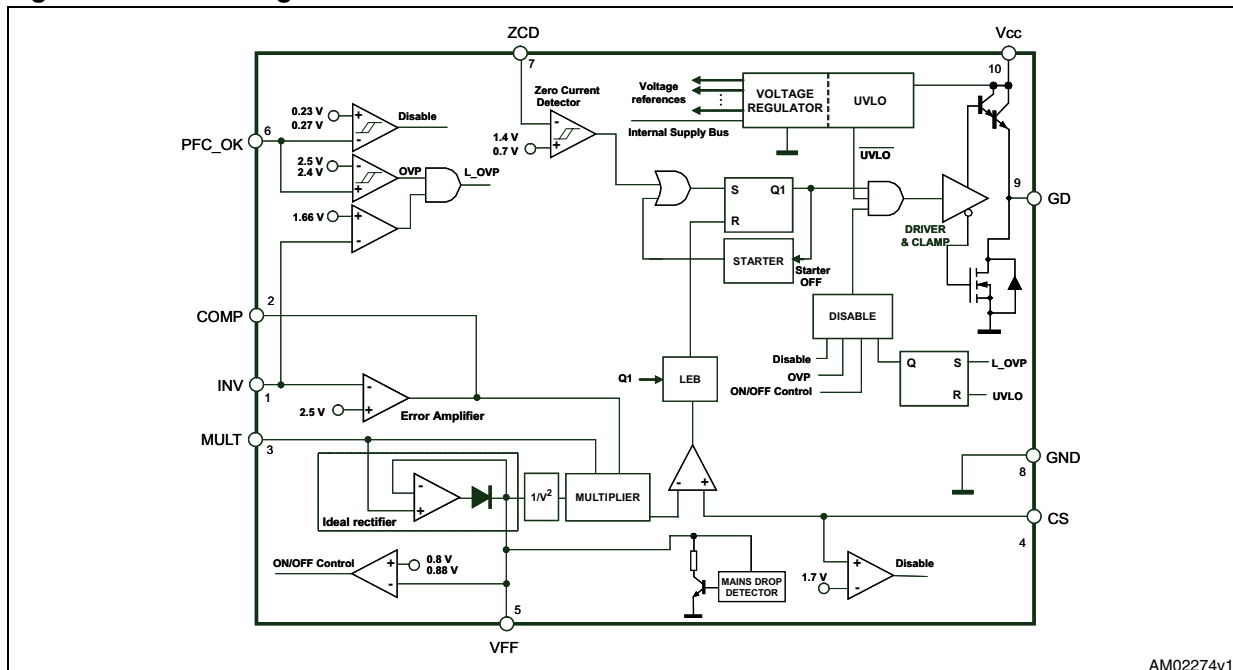
- Guaranteed for extreme temperature range (outdoor)
- Fast “bi-directional” input voltage feedforward ( $1/V^2$  correction)
- Accurate adjustable output overvoltage protection
- Protection against feedback loop disconnection (latched shutdown)
- Inductor saturation protection
- AC brownout detection
- Low ( $\leq 100 \mu\text{A}$ ) startup current
- 6 mA max. operating bias current
- 1% (@  $T_J = 25 \text{ }^\circ\text{C}$ ) internal reference voltage
- -600/+800 mA totem pole gate driver with active pull-down during UVLO
- SSOP10 package



### Applications

- PFC pre-regulators for:
  - High-end AC-DC adapter/charger
  - Desktop PC, server, web server
  - IEC61000-3-2 or JEITA-MITI compliant SMPS
- SMPS for LED luminaires

**Figure 1. Block diagram**



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# 1 Description

The L6564T is a current-mode PFC controller operating in transition mode (TM) and represents the compact version of the L6563S as it embeds the same driver, reference and control stages in a very compact 10-pin SO package.

The highly linear multiplier, along with a special correction circuit that reduces crossover distortion of the mains current, allows wide-range-mains operation with an extremely low THD even over a large load range.

The output voltage is controlled by means of a voltage-mode error amplifier and an accurate (1% @ $T_J = 25\text{ °C}$ ) internal voltage reference. The loop stability is optimized by the voltage feedforward function ( $1/V^2$  correction), which in this IC uses a proprietary technique that also considerably improves line transient response in case of both mains drops and surges (“bidirectional”).

In addition to overvoltage protection able to control the output voltage during transient conditions, the IC also provides protection against feedback loop failures or erroneous settings. Other on-board protection functions allow brownout conditions and boost inductor saturation to be safely handled.

The totem-pole output stage, capable of a 600 mA source and 800 mA sink current, is suitable for a high power MOSFET or IGBT drive. This, combined with the other features and the possibility to operate with ST's proprietary fixed-off-time control, makes the device an excellent solution for SMPS up to 400 W that requires compliance with EN61000-3-2 and JEITA-MITI standards.

## 2 Maximum ratings

### 2.1 Absolute maximum ratings

Table 1. Absolute maximum ratings

Symbol	Pin	Parameter	Value	Unit
V <sub>cc</sub>	10	IC supply voltage ( $I_{cc} \leq 20$ mA)	Self-limited	V
---	1, 3, 6	Max. pin voltage ( $I_{pin} \leq 1$ mA)	Self-limited	V
---	2, 4, 5	Analog inputs and outputs	-0.3 to 8	V
I <sub>ZCD</sub>	7	Zero current detector max. current	-10 (source) 10 (sink)	mA
VFF pin	5	Maximum withstanding voltage range test condition: CDF-AEC-Q100-002 "human body model" Acceptance criteria: "normal performance"	+/- 1750	V
Other pins	1 to 4 6 to 10		+/- 2000	V

### 2.2 Thermal data

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thJA</sub>	Max. thermal resistance, junction-to-ambient	120	°C/W
P <sub>tot</sub>	Power dissipation @ T <sub>A</sub> = 50 °C	0.75	W
T <sub>J</sub>	Junction temperature operating range	-40 to 150	°C
T <sub>stg</sub>	Storage temperature	-55 to 150	°C

### 3 Pin connection

Figure 2. Pin connection

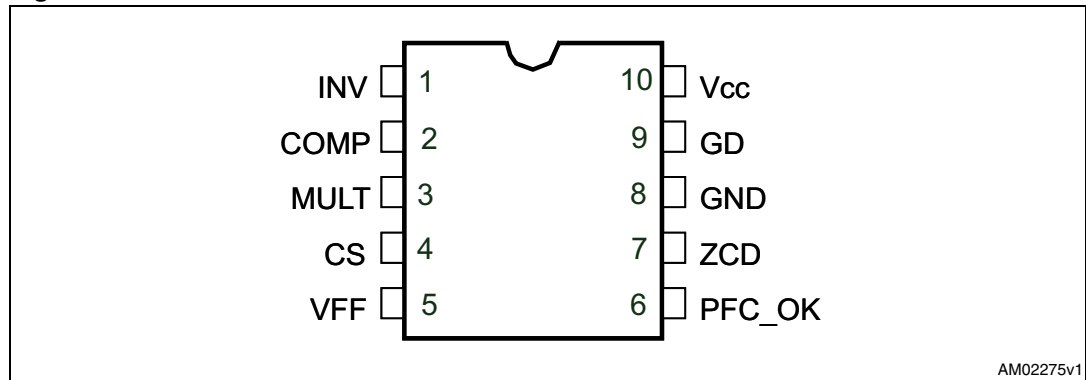


Table 3. Pin description

n°	Name	Function
1	INV	Inverting input of the error amplifier. The information on the output voltage of the PFC pre-regulator is fed into the pin through a resistor divider. The pin normally features high impedance.
2	COMP	Output of the error amplifier. A compensation network is placed between this pin and INV (pin 1) to achieve stability of the voltage control loop and ensure high power factor and low THD. To avoid uncontrolled rise of the output voltage at zero load, when the voltage on the pin falls below 2.4 V the gate driver output is inhibited (burst-mode operation).
3	MULT	Main input to the multiplier. This pin is connected to the rectified mains voltage via a resistor divider and provides the sinusoidal reference to the current loop. The voltage on this pin is used also to derive the information on the RMS mains voltage.
4	CS	Input to the PWM comparator. The current flowing in the MOSFET is sensed through a resistor, the resulting voltage is applied to this pin and compared with an internal reference to determine MOSFET's turn-off. A second comparison level at 1.7 V detects abnormal currents (e.g. due to boost inductor saturation) and, on this occurrence, activates a safety procedure that temporarily stops the converter and limits the stress of the power components.
5	VFF	Second input to the multiplier for $1/V^2$ function. A capacitor and a parallel resistor must be connected from the pin to GND. They complete the internal peak-holding circuit that derives the information on the RMS mains voltage. The voltage at this pin, a DC level equal to the peak voltage on pin MULT (3), compensates the control loop gain dependence on the mains voltage. Never connect the pin directly to GND but with a resistor ranging from 100 K ohm (minimum) to 2 M ohm (maximum). This pin is internally connected to a comparator in order to provide the brownout (AC mains undervoltage) protection. A voltage below 0.8 V shuts down (not latched) the IC and brings its consumption to a considerably lower level. The IC restarts as the voltage at the pin goes above 0.88 V.

Table 3. Pin description (continued)

n°	Name	Function
6	PFC_OK	<p>PFC pre-regulator output voltage monitoring/disable function. This pin senses the output voltage of the PFC pre-regulator through a resistor divider and is used for protection purposes. If the voltage on the pin exceeds 2.5 V the IC stops switching and restarts as the voltage on the pin falls below 2.4 V. However, if at the same time the voltage of the INV pin falls below 1.66 V, a feedback failure is assumed. In this case the device is latched off. Normal operation can be resumed only by cycling Vcc. bringing its value lower than 6 V before moving up to the turn-on threshold.</p> <p>If the voltage on this pin is brought below 0.23 V the IC is shut down. To restart the IC the voltage on the pin must go above 0.27 V. This can be used as a remote on/off control input.</p>
7	ZCD	Boost inductor's demagnetization sensing input for transition-mode operation. A negative-going edge triggers MOSFET's turn-on.
8	GND	Ground. Current return for both the signal part of the IC and the gate driver.
9	GD	Gate driver output. The totem pole output stage is able to drive power MOSFET's and IGBT's with a peak current of 600 mA source and 800 mA sink. The high-level voltage of this pin is clamped at about 12 V to avoid excessive gate voltages.
10	Vcc	Supply voltage of both the signal part of the IC and the gate driver. Sometimes a small bypass capacitor (0.1 $\mu$ F typ.) to GND might be useful to get a clean bias voltage for the signal part of the IC.



## 4 Electrical characteristics

$T_J = -40$  to  $125$  °C,  $V_{CC} = 12$  V,  $C_O = 1$  nF between pin GD and GND,  $C_{FF} = 1$   $\mu$ F and  $R_{FF} = 1$  M $\Omega$  between pin  $V_{FF}$  and GND; unless otherwise specified.

**Table 4. Electrical characteristics**

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
<b>Supply voltage</b>						
$V_{CC}$	Operating range	After turn-on	10.3		22.5	V
$V_{CC_{On}}$	Turn-on threshold	(1)	11	12	13.2	V
$V_{CC_{Off}}$	Turn-off threshold	(1)	8.7	9.5	10.5	V
$V_{CC_{restart}}$	$V_{CC}$ for resuming from latch	OVP latched	5	6	7	V
Hys	Hysteresis		2.3		2.7	V
$V_Z$	Zener voltage	$I_{CC} = 20$ mA	22.5	25	28	V
<b>Supply current</b>						
$I_{start-up}$	Startup current	Before turn-on, $V_{CC} = 10$ V		90	180	$\mu$ A
$I_q$	Quiescent current	After turn-on, $V_{MULT} = 1$ V		4	5.5	mA
$I_{CC}$	Operating supply current	@ 70 kHz		5	6.0	mA
$I_{qdis}$	Idle state quiescent current	$V_{PFC\_OK} > V_{PFC\_OK\_S}$ AND $V_{INV} < V_{FFD}$		180	320	$\mu$ A
		$V_{PFC\_OK} < V_{PFC\_OK\_D}$		1.5	2.5	$\mu$ A
$I_q$	Quiescent current	$V_{PFC\_OK} > V_{PFC\_OK\_S}$ OR $V_{COMP} < 2.3$ V		2.2	3.2	$\mu$ A
<b>Multiplier input</b>						
$I_{MULT}$	Input bias current	$V_{MULT} = 0$ to 3 V		-0.2	-1	$\mu$ A
$V_{MULT}$	Linear operation range		0 to 3			V
$V_{CLAMP}$	Internal clamp level	$I_{MULT} = 1$ mA	9	9.5		V
$\Delta V_{CS}$ $\Delta V_{MULT}$	Output max. slope	$V_{MULT} = 0$ to 0.4 V, $V_{VFF} = 1$ V $V_{COMP} =$ upper clamp	1.33	1.66		V/V
$K_M$	Gain <sup>(2)</sup>	$V_{MULT} = 1$ V, $V_{COMP} = 4$ V	0.375	0.45	0.525	V
<b>Error amplifier</b>						
$V_{INV}$	Voltage feedback input threshold	$T_J = 25$ °C	2.475	2.5	2.525	V
		$10.3$ V < $V_{CC} < 22.5$ V <sup>(3)</sup>	2.45		2.55	
	Line regulation	$V_{CC} = 10.3$ V to 22.5 V		2	5	mV
$I_{INV}$	Input bias current	$V_{INV} = 0$ to 4 V		-0.2	-1	$\mu$ A
$V_{INVCLAMP}$	Internal clamp level	$I_{INV} = 1$ mA	8	9		V
Gv	Voltage gain	Open loop	60	80		dB

**Table 4. Electrical characteristics (continued)**

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
GB	Gain-bandwidth product			1		MHz
I <sub>COMP</sub>	Source current	V <sub>COMP</sub> = 4 V, V <sub>INV</sub> = 2.4 V	1.5	4		mA
	Sink current	V <sub>COMP</sub> = 4 V, V <sub>INV</sub> = 2.6 V	2	4.5		mA
V <sub>COMP</sub>	Upper clamp voltage	I <sub>SOURCE</sub> = 0.5 mA	5.7	6.2	6.7	V
	Burst-mode voltage	<sup>(3)</sup>	2.3	2.4	2.5	
	Lower clamp voltage	I <sub>SINK</sub> = 0.5 mA <sup>(3)</sup>	2.1	2.25	2.4	
<b>Boost inductor saturation detector</b>						
V <sub>CS_th</sub>	Threshold on current sense	<sup>(3)</sup>	1.6	1.7	1.8	V
I <sub>INV</sub>	E/A input pull-up current	After V <sub>CS</sub> > V <sub>CS_th</sub> , before restarting	5	10	13	μA
<b>Startup timer</b>						
t <sub>START_DEL</sub>	Startup delay	First cycle after wake-up	20	50	100	μs
t <sub>START</sub>	Timer period		75	150	350	μs
		Restart after V <sub>CS</sub> > V <sub>CS_th</sub>	150	300	700	
<b>Current sense comparator</b>						
I <sub>CS</sub>	Input bias current	V <sub>CS</sub> = 0			1	μA
t <sub>LEB</sub>	Leading edge blanking		70	150	300	ns
td <sub>(H-L)</sub>	Delay to output		70	200	350	ns
V <sub>CSclamp</sub>	Current sense reference clamp	V <sub>COMP</sub> = upper clamp, V <sub>MULT</sub> = 1 V, V <sub>VFF</sub> = 1 V	0.97	1.08	1.2	V
V <sub>CSofst</sub>	Current sense offset	V <sub>MULT</sub> = 0 V, V <sub>VFF</sub> = 3 V		40	70	mV
		V <sub>MULT</sub> = 3 V, V <sub>VFF</sub> = 3 V		20		
<b>PFC_OK functions</b>						
I <sub>PFC_OK</sub>	Input bias current	V <sub>PFC_OK</sub> = 0 to 2.6 V		-0.1	-1	μA
V <sub>PFC_OK_C</sub>	Clamp voltage	I <sub>PFC_OK</sub> = 1 mA	8.5	9.5		V
V <sub>PFC_OK_S</sub>	OVP threshold	<sup>(1)</sup> Voltage rising	2.435	2.5	2.565	V
V <sub>PFC_OK_R</sub>	Restart threshold after OVP	<sup>(1)</sup> Voltage falling	2.34	2.4	2.46	V
V <sub>PFC_OK_D</sub>	Disable threshold	<sup>(1)</sup> Voltage falling	0.08		0.40	V
V <sub>PFC_OK_D</sub>	Disable threshold	<sup>(1)</sup> Voltage falling T <sub>j</sub> = 25 °C	0.17	0.23	0.29	V
V <sub>PFC_OK_E</sub>	Enable threshold	<sup>(1)</sup> Voltage rising	0.10		0.43	V
V <sub>PFC_OK_E</sub>	Enable threshold	<sup>(1)</sup> Voltage rising T <sub>j</sub> = 25 °C	0.21	0.27	0.32	V
V <sub>FFD</sub>	Feedback failure detection threshold (V <sub>INV</sub> falling)	V <sub>PFC_OK</sub> = V <sub>PFC_OK_S</sub>	1.61	1.66	1.71	V

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
<b>Voltage feedforward</b>						
V <sub>VFF</sub>	Linear operation range		1		3	V
ΔV	Dropout V <sub>MULTpk</sub> -V <sub>VFF</sub>	V <sub>CC</sub> < V <sub>CCOn</sub>			850	mV
		V <sub>CC</sub> > or = to V <sub>CCOn</sub>			20	
ΔV <sub>VFF</sub>	Line drop detection thresh.	Below peak value	30	70	110	mV
ΔV <sub>VFF</sub>	Line drop detection thresh.	Below peak value T <sub>j</sub> = 25°C	50	70	90	mV
R <sub>DISCH</sub>	Internal discharge resistor	T <sub>j</sub> = 25 °C	7.5	10	12.5	kΩ
			5		20	
V <sub>DIS</sub>	Disable threshold	<sup>(2)</sup> Voltage falling	0.725	0.8	0.875	V
V <sub>EN</sub>	Enable threshold	<sup>(2)</sup> Voltage rising	0.845	0.88	0.915	V
<b>Zero current detector</b>						
V <sub>ZCDH</sub>	Upper clamp voltage	I <sub>ZCD</sub> = 2.5 mA	5.0	5.7		V
V <sub>ZCDL</sub>	Lower clamp voltage	I <sub>ZCD</sub> = - 2.5 mA	-0.3	0	0.3	V
V <sub>ZCDA</sub>	Arming voltage (positive-going edge)		1.1	1.4	1.9	V
V <sub>ZCDT</sub>	Triggering voltage (negative-going edge)		0.5	0.7	1	V
I <sub>ZCDB</sub>	Input bias current	V <sub>ZCD</sub> = 1 to 4.5 V			1	μA
I <sub>ZCDsrc</sub>	Source current capability		-2.0	-4		mA
I <sub>ZCDsnk</sub>	Sink current capability		2.0	5		mA
<b>Gate driver</b>						
V <sub>OL</sub>	Output low voltage	I <sub>sink</sub> = 100 mA		0.6	1.4	V
V <sub>OH</sub>	Output high voltage	I <sub>source</sub> = 5 mA	9.5	10.3		V
I <sub>srcpk</sub>	Peak source current		-0.6			A
I <sub>snkpk</sub>	Peak sink current		0.8			A
t <sub>f</sub>	Voltage fall time			30	60	ns
t <sub>r</sub>	Voltage rise time			45	150	ns
V <sub>Oclamp</sub>	Output clamp voltage	I <sub>source</sub> = 5 mA; V <sub>CC</sub> = 20 V	10	12	15	V
	UVLO saturation	V <sub>CC</sub> = 0 to V <sub>CCOn</sub> , I <sub>sink</sub> = 2 mA			1.2	V

1. Parameters tracking each other.

2. The multiplier output is given by:  $V_{CS} = V_{CS\_Ofst} + K_M \cdot \frac{V_{MULT} \cdot (V_{COMP} - 2.5)}{V_{VFF}^2}$

3. Parameters tracking each other.

# 5 Typical electrical performance

Figure 3. IC consumption vs.  $V_{CC}$

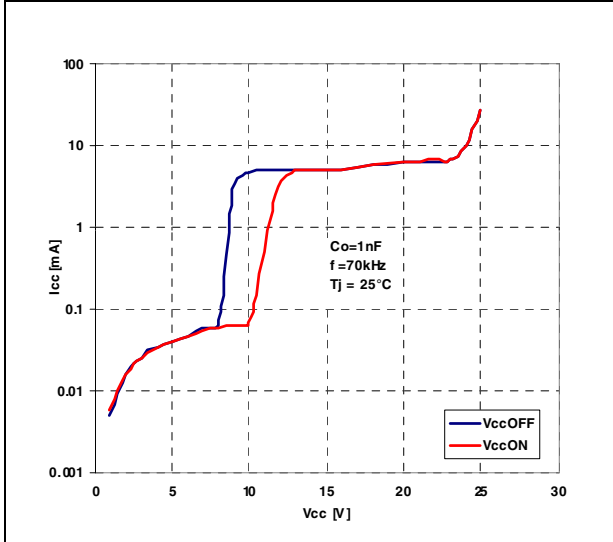


Figure 4. IC consumption vs.  $T_j$

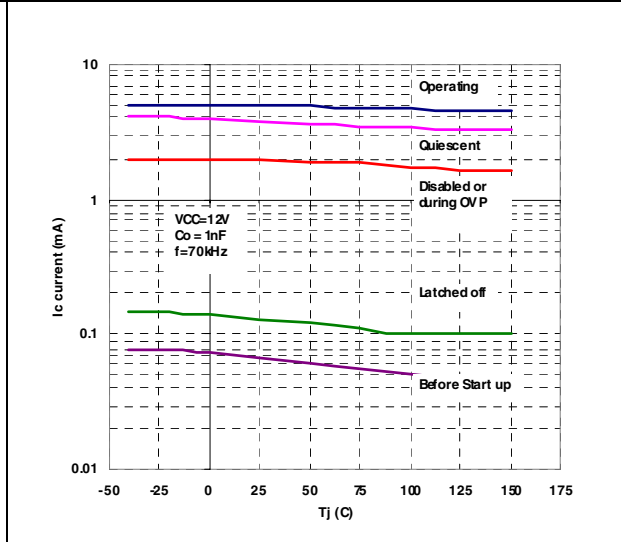


Figure 5.  $V_{CC}$  Zener voltage vs.  $T_j$

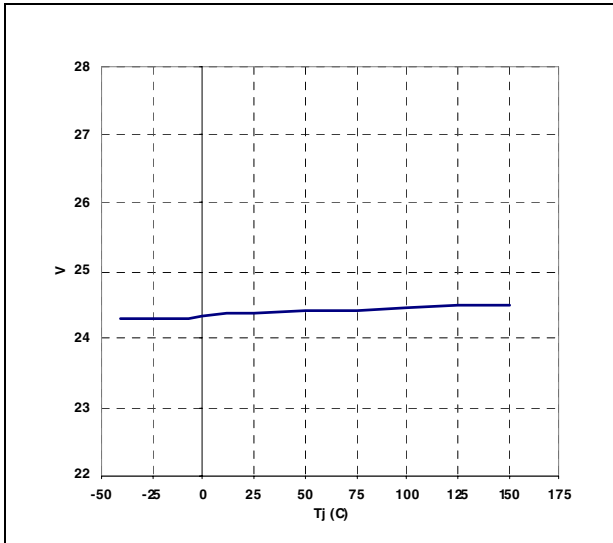


Figure 6. Startup and UVLO vs.  $T_j$

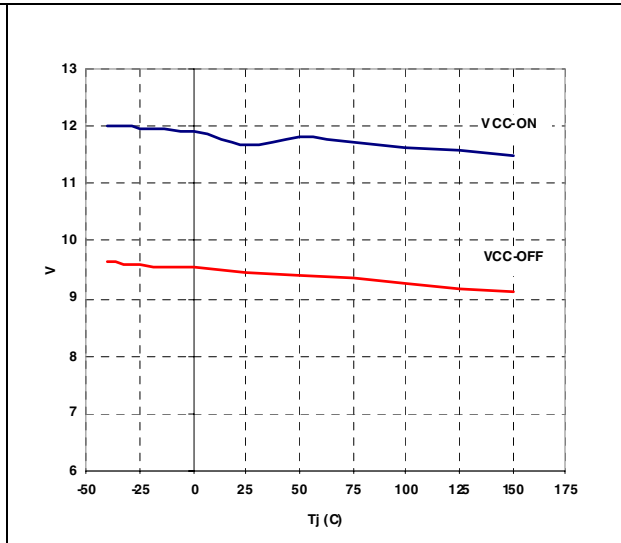


Figure 7. Feedback reference vs.  $T_J$

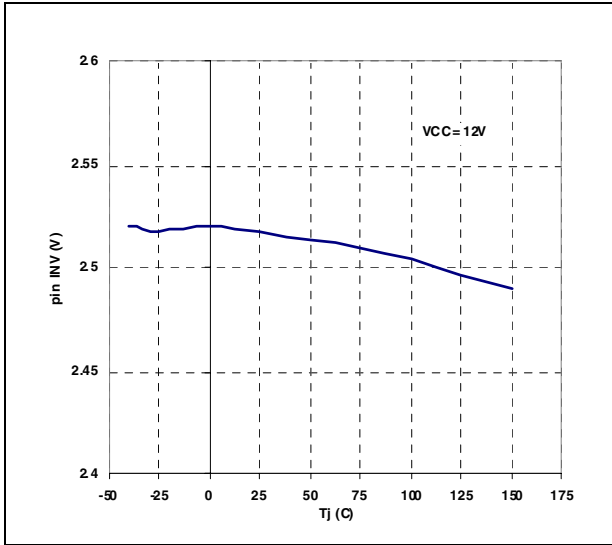


Figure 8. E/A output clamp levels vs.  $T_J$

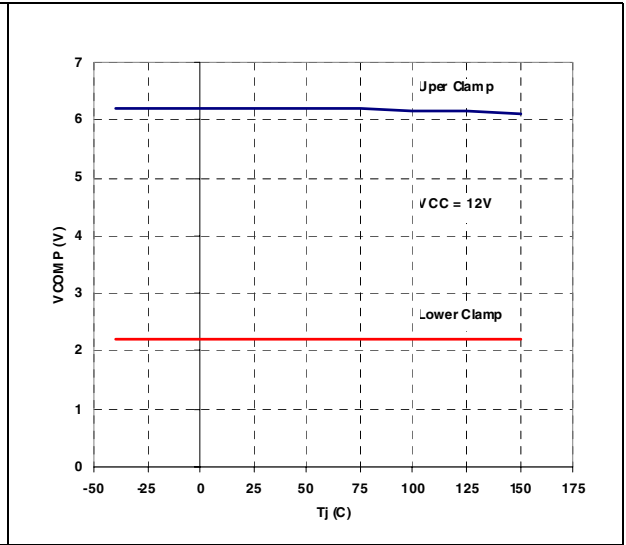


Figure 9. UVLO saturation vs.  $T_J$

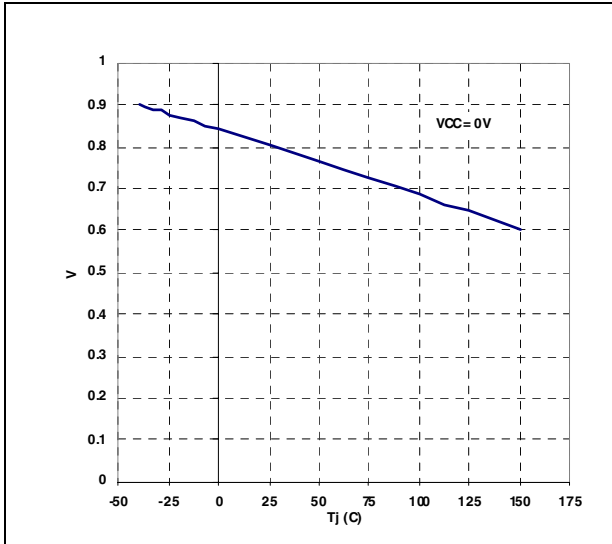


Figure 10. OVP levels vs.  $T_J$

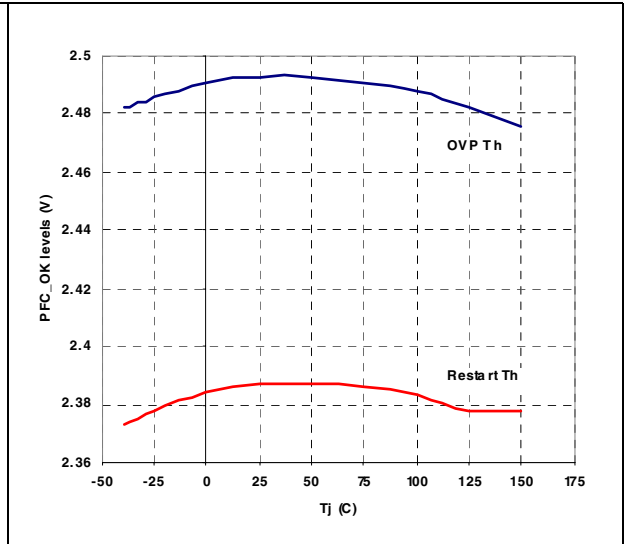


Figure 11. Inductor saturation threshold vs.  $T_J$  Figure 12.  $V_{CS}$  clamp vs.  $T_J$

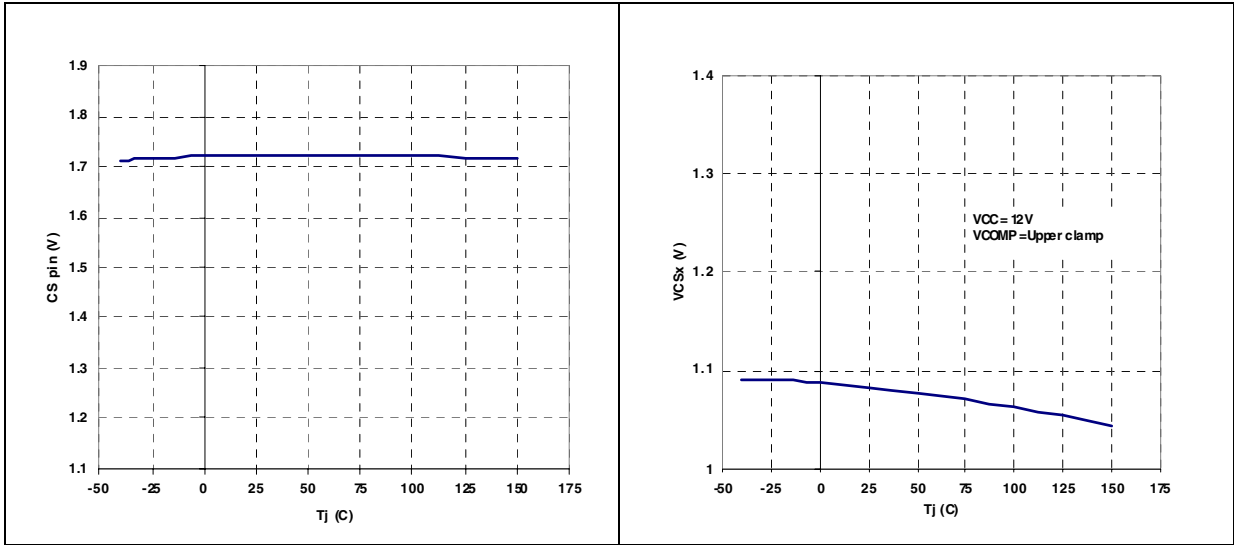


Figure 13. ZCD sink/source capability vs.  $T_J$  Figure 14. ZCD clamp level vs.  $T_J$

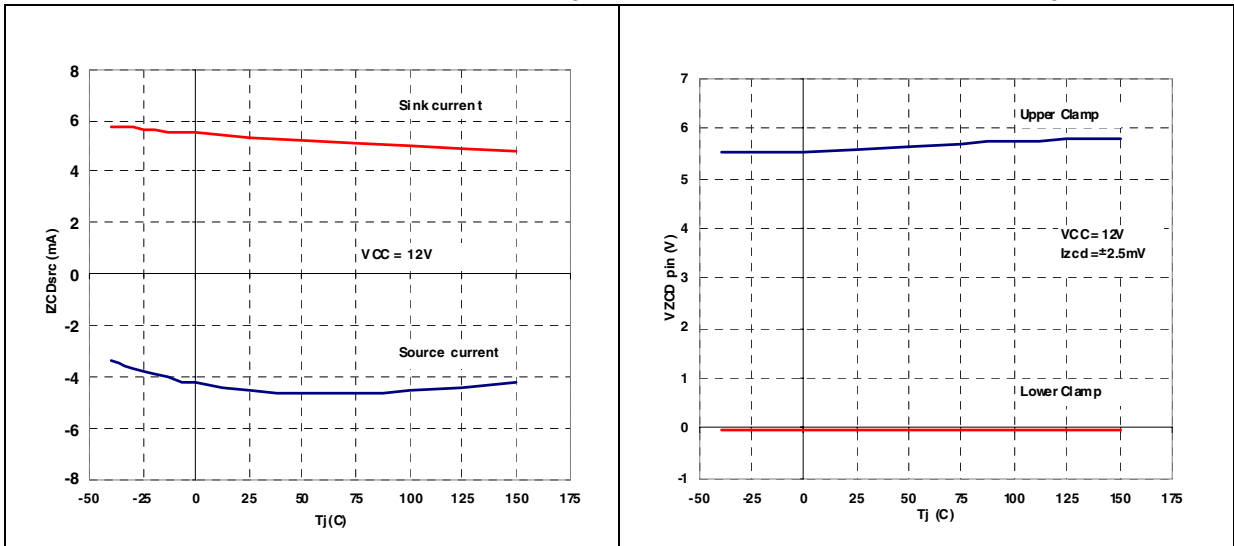


Figure 15. R discharge vs. T<sub>J</sub>

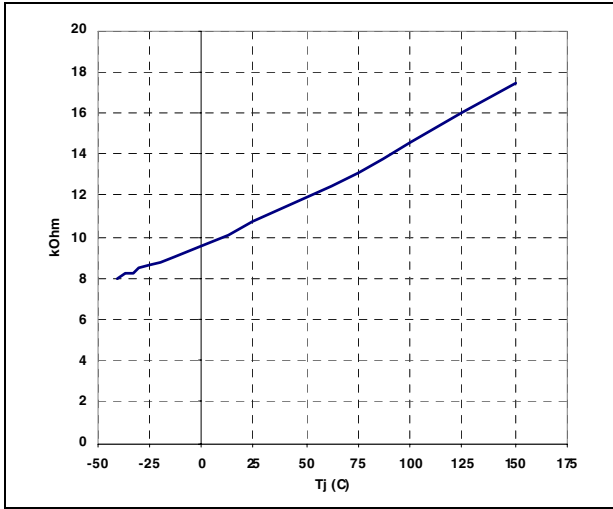


Figure 16. Line drop detection threshold vs. T<sub>J</sub>

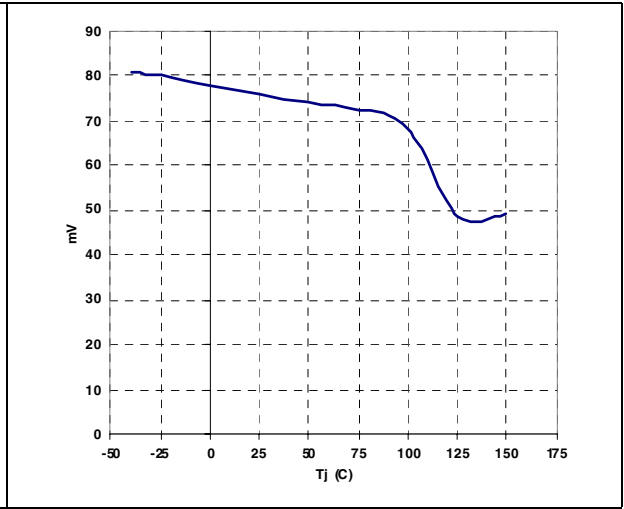


Figure 17. V<sub>MULTpk</sub> - V<sub>VFF</sub> dropout vs. T<sub>J</sub>

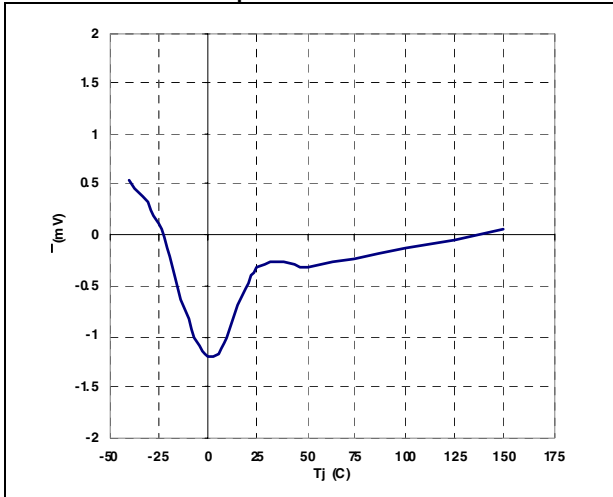


Figure 18. PFC\_OK threshold vs. T<sub>J</sub>

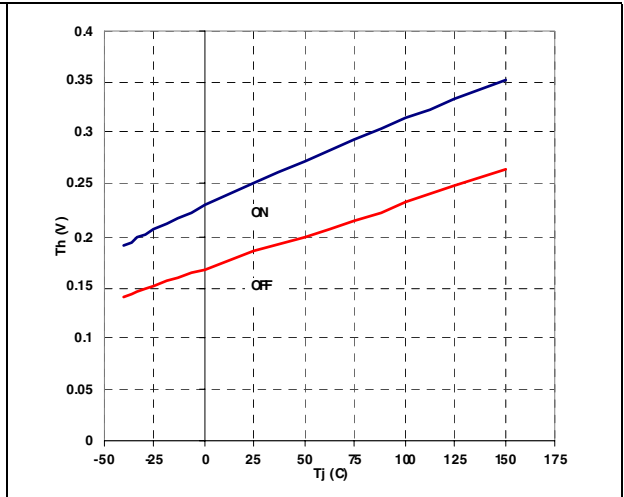


Figure 19. PFC\_OK FFD threshold vs. T<sub>J</sub>

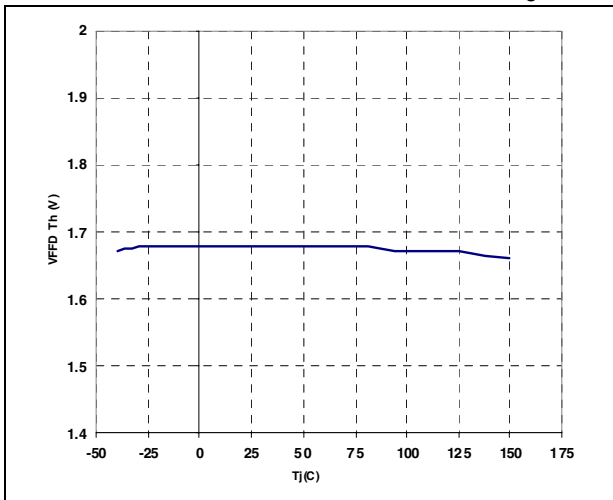


Figure 20. Multiplier characteristics  
@  $V_{FF} = 1\text{ V}$

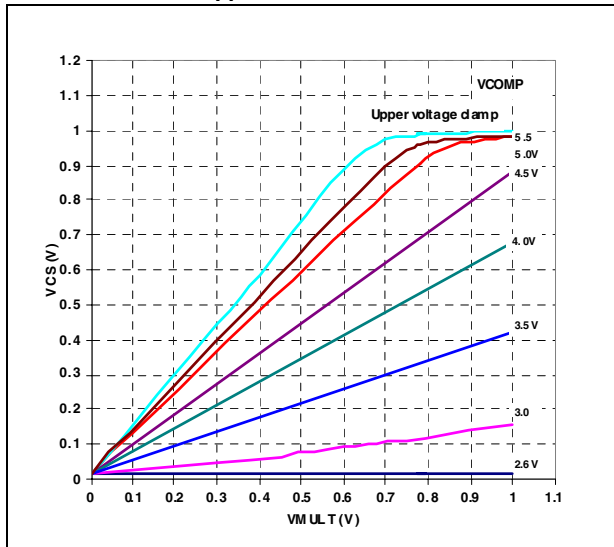


Figure 21. Multiplier characteristics  
@  $V_{FF} = 3\text{ V}$

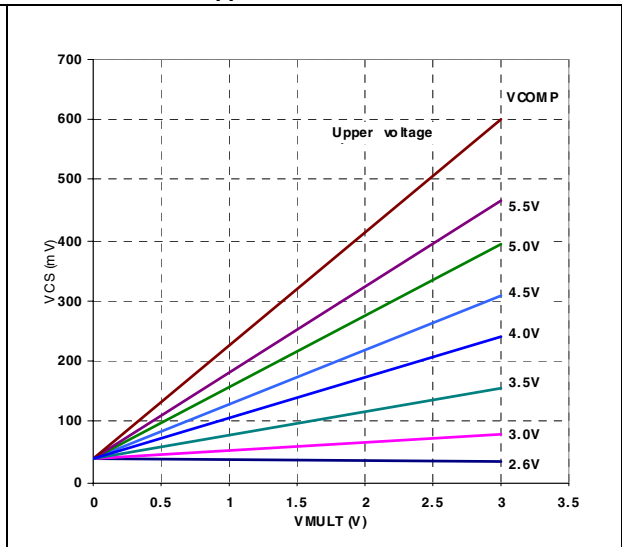


Figure 22. Multiplier gain vs.  $T_J$

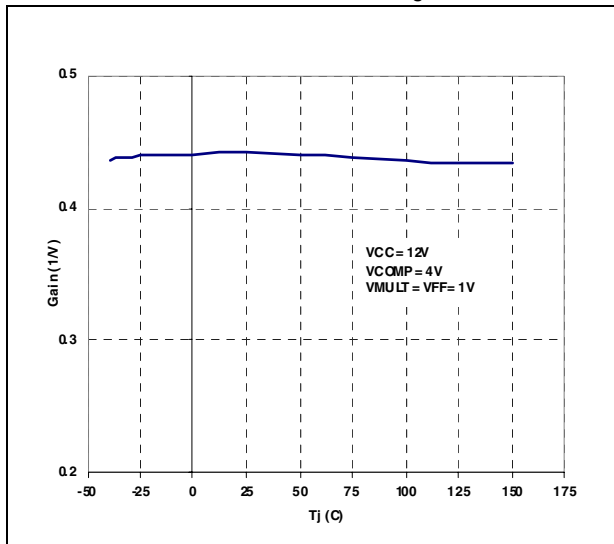


Figure 23. Gate drive clamp vs.  $T_J$

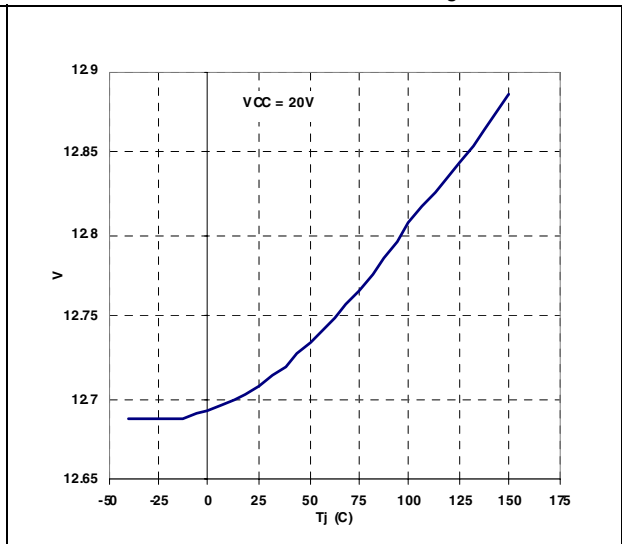




Figure 24. Gate drive output saturation vs.  $T_J$  Figure 25. Delay to output vs.  $T_J$

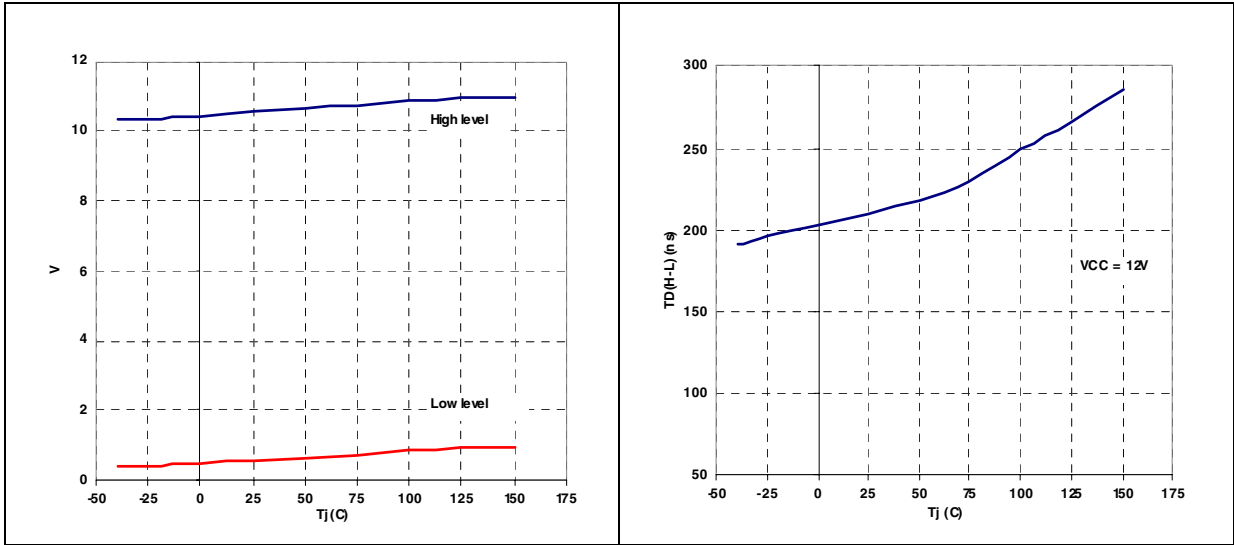
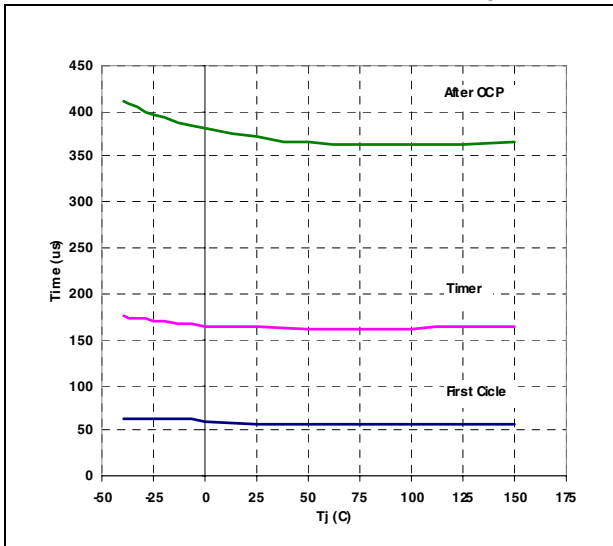


Figure 26. Startup timer period vs.  $T_J$



## 6 Application information

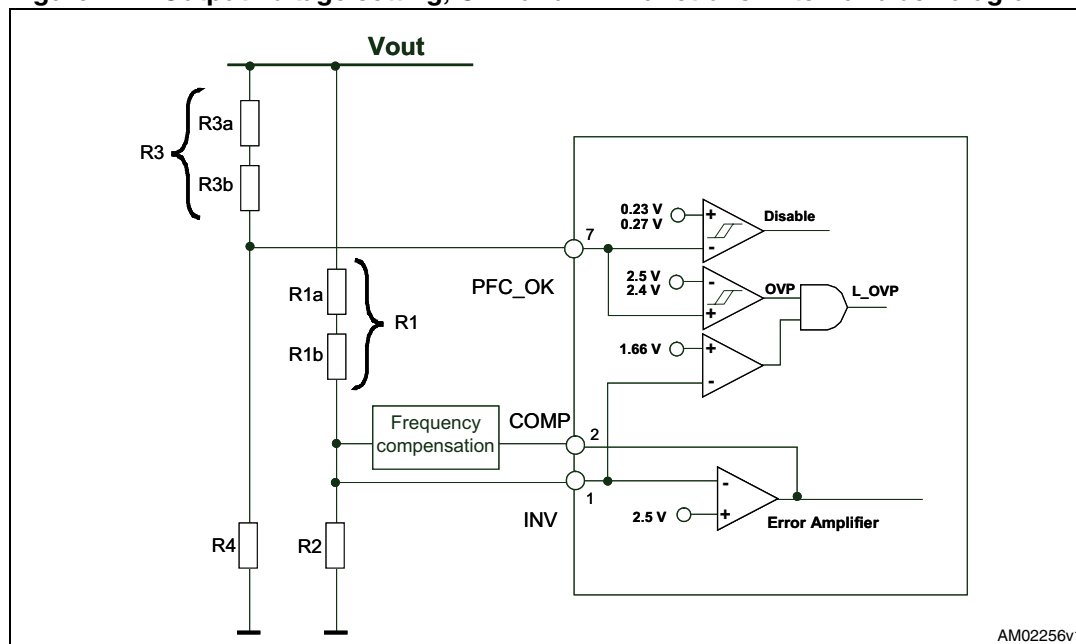
### 6.1 Overvoltage protection

Normally, the voltage control loop keeps the output voltage  $V_o$  of the PFC pre-regulator close to its nominal value, set by the ratio of the resistors R1 and R2 of the output divider. A pin of the device (PFC\_OK) has been dedicated to monitor the output voltage with a separate resistor divider (R3 high, R4 low, see [Figure 27](#)). This divider is selected so that the voltage at the pin reaches 2.5 V if the output voltage exceeds a preset value, usually larger than the maximum  $V_o$  that can be expected.

Example:  $V_o = 400\text{ V}$ ,  $V_{OX} = 434\text{ V}$ . Select:  $R3 = 8.8\text{ M}\Omega$ ; then:  $R4 = 8.8\text{ M}\Omega \cdot 2.5 / (434 - 2.5) = 51\text{ k}\Omega$

When this function is triggered, the gate drive activity is immediately stopped until the voltage on the pin PFC\_OK drops below 2.4 V. Note that R1, R2, R3 and R4 can be selected without any constraints. The unique criterion is that both dividers have to sink a current from the output bus which needs to be significantly higher than the bias current of both INV and PFC\_OK pins.

**Figure 27. Output voltage setting, OVP and FFP functions: internal block diagram**



## 6.2 Feedback failure protection (FFP)

The OVP function described above handles “normal” overvoltage conditions, i.e. those resulting from an abrupt load/line change or occurring at startup. In case the overvoltage is generated by a feedback disconnection, for instance when the upper resistor of the output divider (R1) fails to open, the comparator detects the voltage at pin INV. If the voltage is lower than 1.66 V and the OVP is active, the FFP is triggered, the gate drive activity is immediately stopped, the device is shut down, its quiescent consumption is reduced below 180  $\mu$ A and the condition is latched as long as the supply voltage of the IC is above the UVLO threshold. To restart the system it is necessary to recycle the input power, so that the Vcc voltage of the L6564T goes below 6 V.

The pin PFC\_OK doubles its function as a not-latched IC ‘Disable’: a voltage below 0.23 V shuts down the IC, reducing its consumption below 2 mA. To restart the IC simply let the voltage at the pin go above 0.27 V.

Note that these functions offer complete protection against not only feedback loop failures or erroneous settings, but also against a failure of the protection itself. Either resistor of the PFC\_OK divider failing short or open or a PFC\_OK pin floating results in shutting down the IC and stopping the pre-regulator.

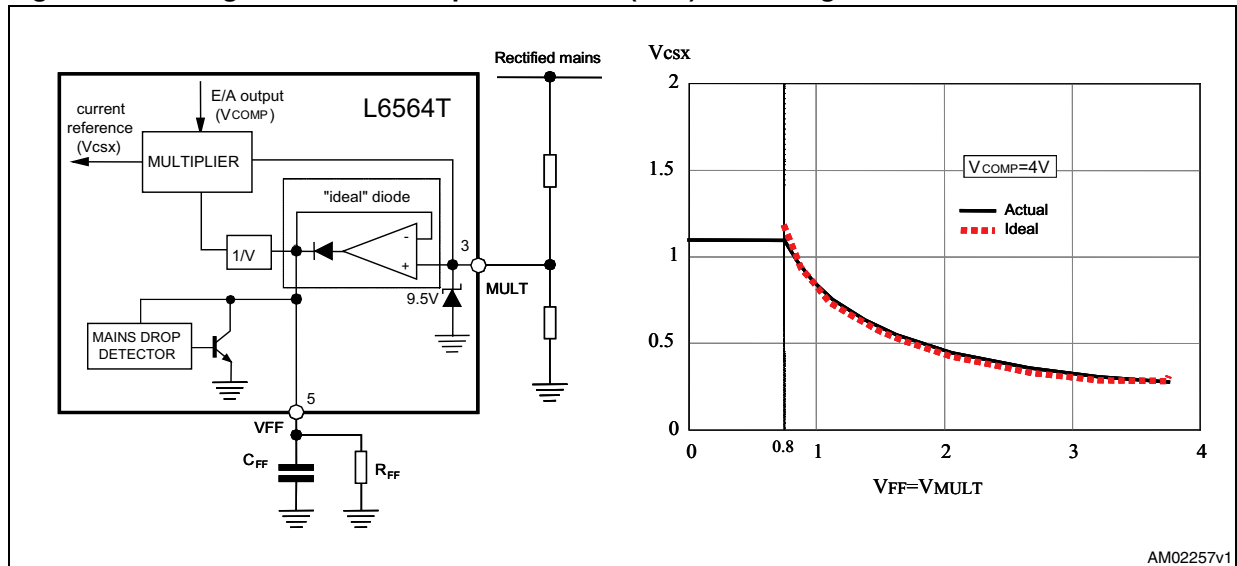
## 6.3 Voltage feedforward

The power stage gain of PFC pre-regulators varies with the square of the RMS input voltage. So does the crossover frequency FC of the overall open-loop gain because the gain has a single pole characteristic. This leads to a large trade-off in the design.

For example, setting the gain of the error amplifier to get FC = 20 Hz @ 264 Vac means having FC 4 Hz @ 88 Vac, resulting in a sluggish control dynamics. Additionally, the slow control loop causes large transient current flow during rapid line or load changes that are limited by the dynamics of the multiplier output. This limit is considered when selecting the sense resistor to let the full load power pass under minimum line voltage conditions, with some margin. But a fixed current limit allows excessive power input at high line, whereas a fixed power limit requires the current limit to vary inversely with the line voltage.

Voltage feedforward can compensate for the gain variation with the line voltage and allow the minimizing of all the above-mentioned issues. It consists in deriving a voltage proportional to the input RMS voltage, feeding this voltage into a squarer/divider circuit ( $1/V^2$  corrector) and providing the resulting signal to the multiplier that generates the current reference for the inner current control loop (see [Figure 28](#)).

Figure 28. Voltage feedforward: squarer/divider ( $1/V^2$ ) block diagram and transfer characteristic



In this way a change of the line voltage causes an inversely proportional change of the half sine amplitude at the output of the multiplier (if the line voltage doubles the amplitude of the multiplier output is halved and vice versa) so that the current reference is adapted to the new operating conditions with (ideally) no need for invoking the slow dynamics of the error amplifier. Additionally, the loop gain is constant throughout the input voltage range, which significantly improves dynamic behavior at low line and simplifies loop design.

In fact, deriving a voltage proportional to the RMS line voltage implies a form of integration, which has its own time constant. If it is too small the voltage generated is affected by a considerable amount of ripple at twice the mains frequency that causes distortion of the current reference (resulting in high THD and poor PF); if it is too large there is a considerable delay in setting the right amount of feedforward, resulting in excessive overshoot and undershoot of the pre-regulator's output voltage in response to large line voltage changes. Clearly a trade-off was required.

The L6564T realizes a NEW voltage feed forward that, with a technique that makes use of just two external parts, strongly minimizes this time constant trade-off issue whichever voltage change occurs on the mains, both surges and drops. A capacitor  $C_{FF}$  and a resistor  $R_{FF}$ , both connected from pin VFF (#5) to ground, complete an internal peak-holding circuit that provides a DC voltage equal to the peak of the rectified sine wave applied on pin MULT (#3). In this way, in case of sudden line voltage rise,  $C_{FF}$  is rapidly charged through the low impedance of the internal diode; in case of line voltage drop, an internal "mains drop" detector enables a low impedance switch which suddenly discharges  $C_{FF}$  avoiding long settling time before reaching the new voltage level. The discharge of  $C_{FF}$  is stopped as its voltage equals the voltage on the MULT pin or if the voltage on the VFF pin falls below 0.88 V, to prevent the "Brownout protection" function from being improperly activated (see [Section 6.3](#)).

As a result of the VFF pin functionality, an acceptably low steady-state ripple and low current distortion can be achieved with a limited undershoot or overshoot on the pre-regulator's output.

The twice-mains-frequency ( $2 \cdot f_L$ ) ripple appearing across  $C_{FF}$  is triangular with a peak-to-peak amplitude that, with good approximation, is given by:

$$\Delta V_{FF} = \frac{2V_{MULTpk}}{1 + 4f_L R_{FF} C_{FF}}$$

where  $f_L$  is the line frequency. The amount of 3rd harmonic distortion introduced by this ripple, related to the amplitude of its  $2 \cdot f_L$  component, is:

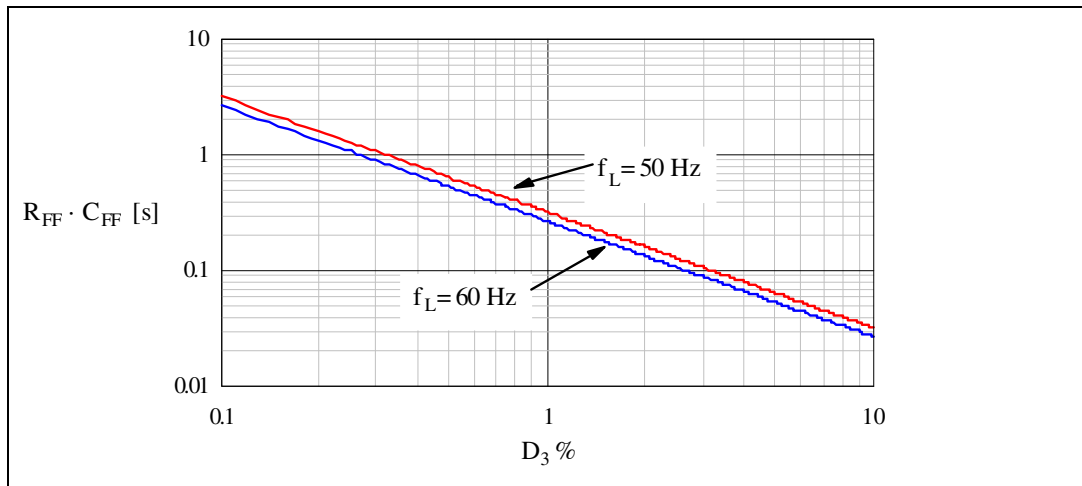
$$D_3 \% = \frac{100}{2\pi f_L R_{FF} C_{FF}}$$

Figure 29 shows a diagram that helps choose the time constant  $R_{FF} \cdot C_{FF}$  based on the amount of maximum desired 3rd harmonic distortion. Note that there is a minimum value for the time constant  $R_{FF} \cdot C_{FF}$  below which improper activation of the VFF fast discharge may occur. In fact, the twice-mains-frequency ripple across  $C_{FF}$  under steady-state conditions must be lower than the minimum line drop detection threshold ( $\Delta V_{FF\_min} = 40$  mV). Therefore:

$$R_{FF} \cdot C_{FF} > \frac{2 \frac{V_{MULTpk\_max}}{\Delta V_{VFF\_min}} - 1}{4f_{L\_min}}$$

Always connect RFF and CFF to the pin, the IC does not work properly if the pin is either left floating or connected directly to ground.

**Figure 29.  $R_{FF} \cdot C_{FF}$  as a function of 3rd harmonic distortion introduced in the input current**



### 6.4 THD optimizer circuit

The L6564T is provided with a special circuit that reduces the conduction dead-angle occurring to the AC input current near the zero-crossings of the line voltage (crossover distortion). In this way the THD (total harmonic distortion) of the current is considerably reduced.

A major cause of this distortion is the inability of the system to transfer energy effectively when the instantaneous line voltage is very low. This effect is magnified by the high-frequency filter capacitor placed after the bridge rectifier, which retains some residual voltage that causes the diodes of the bridge rectifier to be reverse-biased and the input current flow to temporarily stop.

To overcome this issue the device forces the PFC pre-regulator to process more energy near the line voltage zero-crossings as compared to that commanded by the control loop. This results in both minimizing the time interval where energy transfer is lacking and fully discharging the high-frequency filter capacitor after the bridge.

Figure 30 shows the internal block diagram of the THD optimizer circuit.

Figure 30. THD optimizer circuit

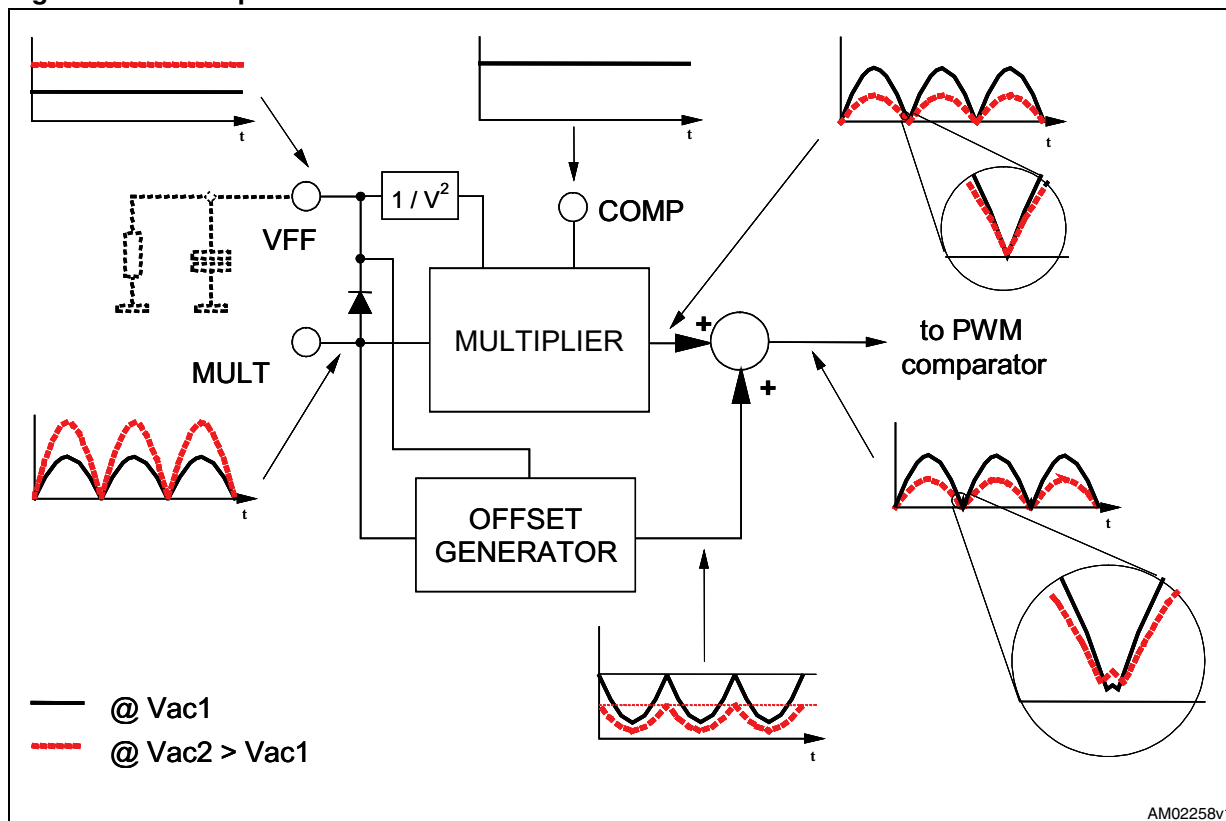
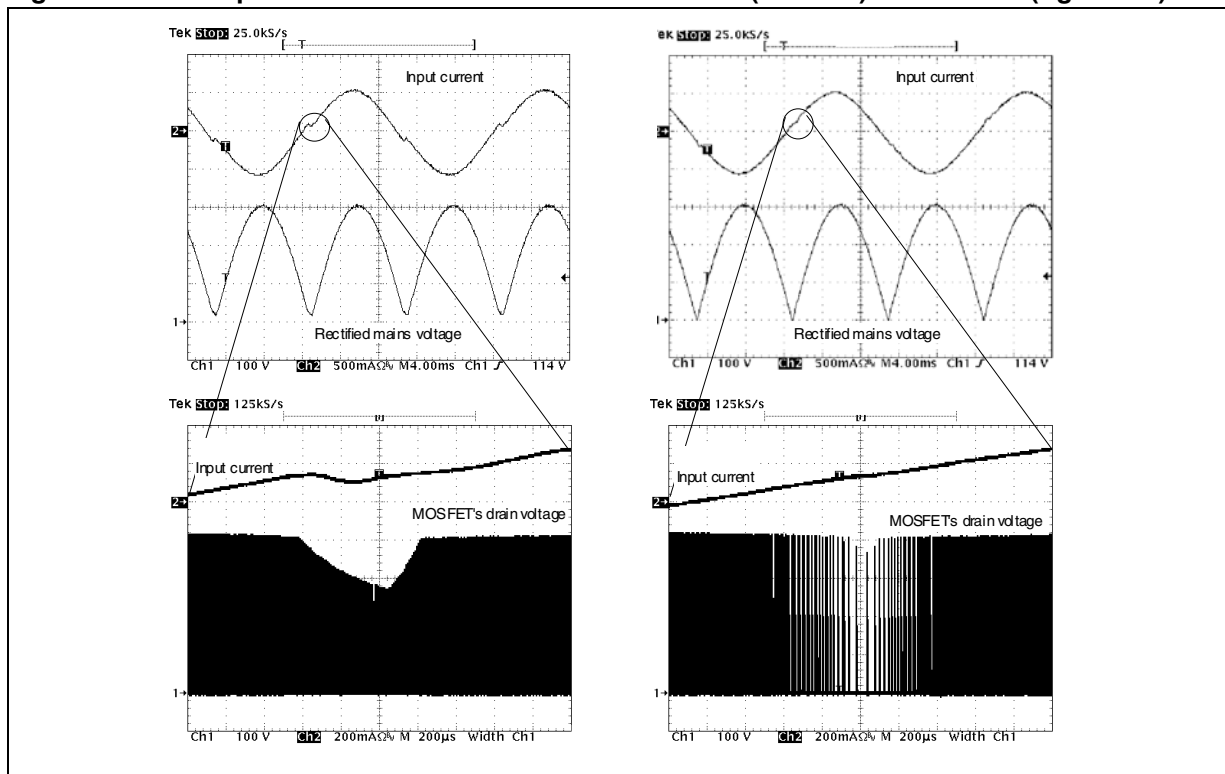


Figure 31. THD optimization: standard TM PFC controller (left side) and L6564T (right side)



Essentially, the circuit artificially increases the ON-time of the power switch with a positive offset added to the output of the multiplier in the proximity of the line voltage zero-crossings. This offset is reduced as the instantaneous line voltage increases, so that it becomes negligible as the line voltage moves toward the top of the sinusoid. Furthermore, the offset is modulated by the voltage on the VFF pin (see [Section 6.3](#)) so as to have little offset at low line, where energy transfer at zero crossings is typically quite good, and a larger offset at high line where the energy transfer gets worse.

The effect of the circuit is shown in [Figure 31](#), where the key waveforms of a standard TM PFC controller are compared to those of this chip.

To take maximum benefit from the THD optimizer circuit, the high-frequency filter capacitor after the bridge rectifier should be minimized, compatibly with EMI filtering needs. A large capacitance, in fact, introduces a conduction dead-angle of the AC input current in itself - even with an ideal energy transfer by the PFC pre-regulator - therefore reducing the effectiveness of the optimizer circuit.

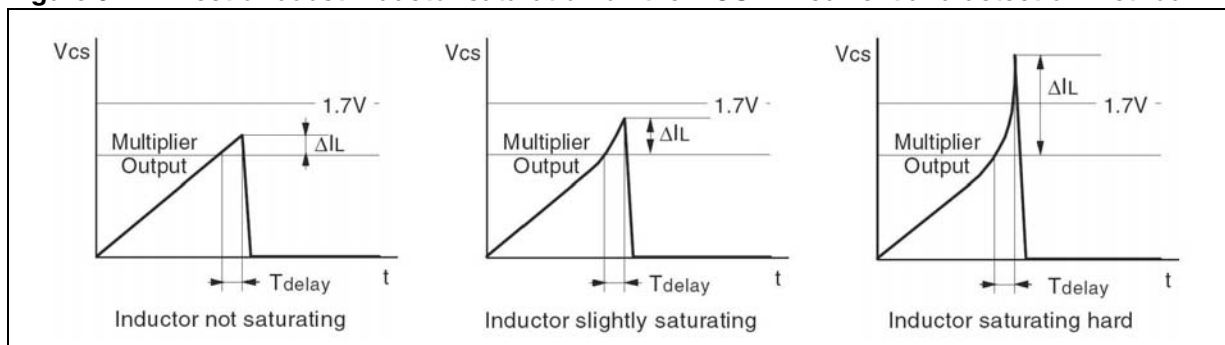
## 6.5 Inductor saturation detection

The boost inductor's hard saturation may be a fatal event for a PFC pre-regulator: the current up-slope becomes so large (50-100 times steeper, see [Figure 32](#)) that during the current sense propagation delay the current may reach abnormally high values. The voltage drop caused by this abnormal current on the sense resistor reduces the gate-to-source voltage, so that the MOSFET may work in the active region and dissipate a huge amount of power, which leads to a catastrophic failure after few switching cycles.

However, in some applications such as AC-DC adapters, where the PFC pre-regulator is turned off at light load for energy saving reasons, even a well-designed boost inductor may occasionally slightly saturate when the PFC stage is restarted because of a larger load demand. This happens when the restart occurs at an unfavorable line voltage phase, i.e. when the output voltage is significantly below the rectified peak voltage. As a result, in the boost inductor the inrush current coming from the bridge rectifier adds up to the switched current and, furthermore, there is little or no voltage available for demagnetization.

To cope with a saturated inductor, the L6564T is provided with a second comparator on the current sense pin (CS, pin 4) that stops the IC if the voltage, normally limited within 1.1 V, exceeds 1.7 V. After that, the IC is attempted to restart by the internal starter circuitry; the starter repetition time is twice the nominal value to guarantee lower stress for the inductor and boost diode. Hence, the system safety is considerably increased.

Figure 32. Effect of boost inductor saturation on the MOSFET current and detection method

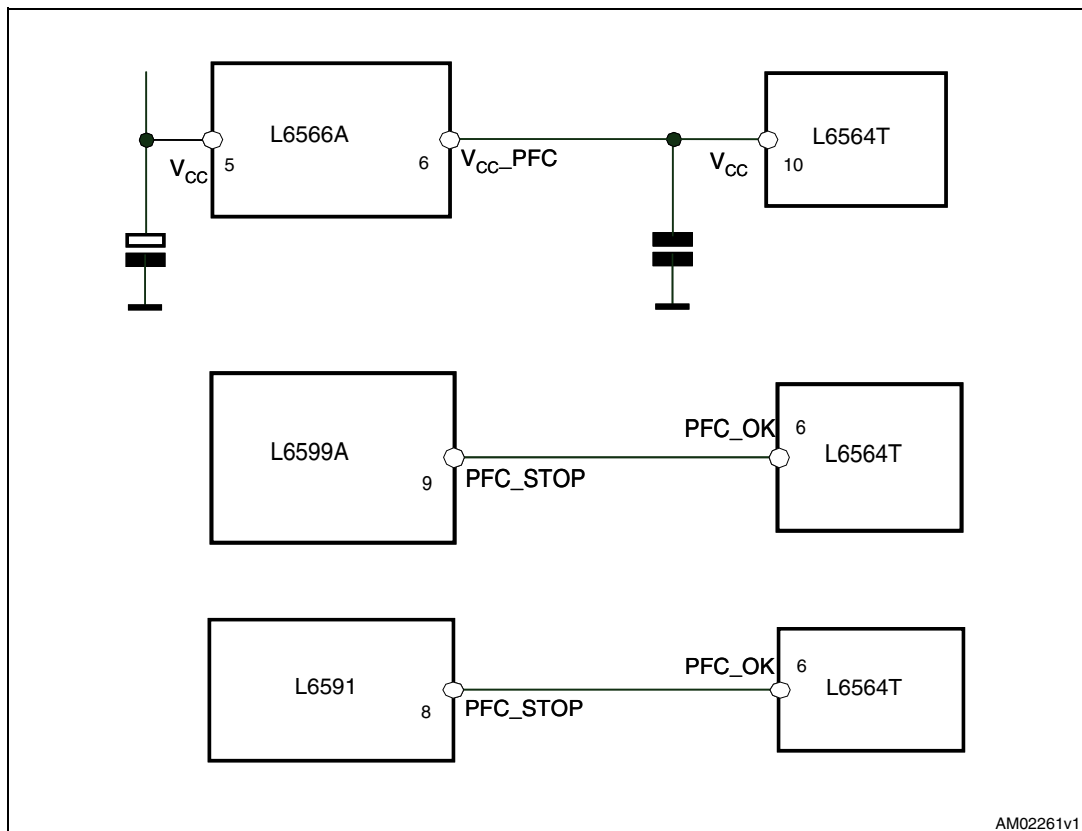




## 6.6 Power management/housekeeping functions

A communication line with the control IC of the cascaded DC-DC converter can be established via the disable function included in the PFC\_OK pin (see [Section 6.2](#) for more details). This line is typically used to allow the PWM controller of the cascaded DC-DC converter to shut down the L6564T in case of light load and to minimize the no-load input consumption. Should the residual consumption of the chip be an issue, it is also possible to cut down the supply voltage. The interface circuits are shown in [Figure 32](#). Needless to say, this operation assumes that the cascaded DC-DC converter stage works as the master and the PFC stage as the slave or, in other words, that the DC-DC stage starts first, it powers both controllers and enables/disables the operation of the PFC stage.

**Figure 33. Interface circuits that let DC-DC converter's controller IC disable the L6564T**



Another function available is the brownout protection which is basically a not-latched shutdown function that is activated when a condition of mains undervoltage is detected. This condition may cause overheating of the primary power section due to an excess of RMS current. Brownout can also cause the PFC pre-regulator to function in open loop and this may be dangerous to the PFC stage itself and the downstream converter, should the input voltage return abruptly to its rated value. Another problem is the spurious restarts that may occur during converter power-down and that cause the output voltage of the converter not to decay to zero monotonically. For these reasons it is usually preferable to shut down the unit in case of brownout. The brownout threshold is internally fixed at 0.8 V and is sensed on pin VFF (5) during the voltage falling and an 80 mV threshold hysteresis prevents rebounding at input voltage turn-off. In [Table 5](#) it is possible to find a summary of all of the above mentioned working conditions that cause the device to stop operating.

**Table 5. Summary of L6564 idle states**

Condition	Caused or revealed by	IC behavior	Restart condition	Typical IC consumption
UVLO	$V_{cc} < V_{ccOff}$	Disabled	$V_{cc} > V_{ccOn}$	90 $\mu$ A
Feedback disconnected	$PFC\_OK > V_{PFC\_OK\_S}$ and $INV < 1.66$ V	Latched	$V_{cc} < V_{ccrestart}$ then $V_{cc} > V_{ccOn}$	180 $\mu$ A
Standby	$PFC\_OK < V_{PFC\_OK\_D}$	Stop switching	$PFC\_OK > V_{PFC\_OK\_E}$	1.5 mA
AC brownout	$V_{FF} < V_{DIS}$	Stop switching	$RUN > V_{EN}$	1.5 mA
OVP	$PFC\_OK > V_{PFC\_OK\_S}$	Stop Switching	$PFC\_OK < V_{PFC\_OK\_R}$	2.2 mA
Low consumption	$COMP < 2.4$ V	Burst mode	$COMP > 2.4$ V	2.2 mA
Saturated boost inductor	$V_{cs} > V_{CS\_th}$	Doubled $T_{start}$	Auto restart	2.2 mA

# 7 Application examples and ideas

Figure 34. Demonstration board EVL6564-100W, wide-range mains: electrical schematic

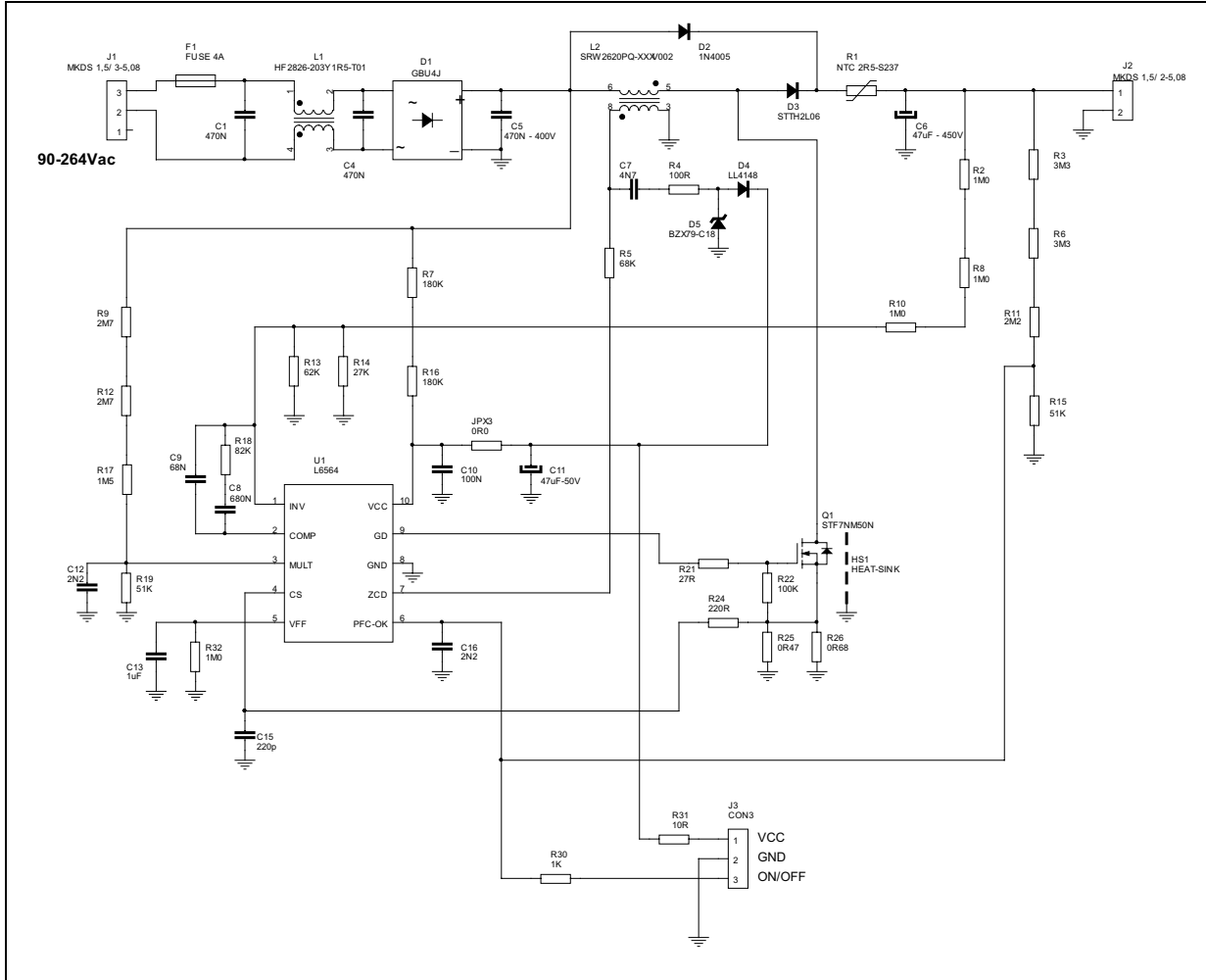


Figure 35. L6564 100 W TM PFC: compliance with EN61000-3-2 standard

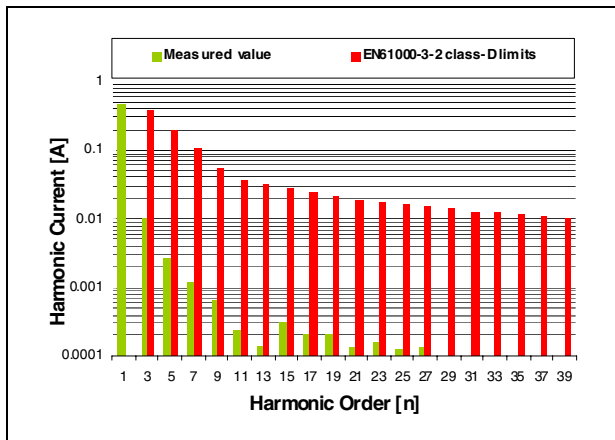


Figure 36. L6564 100 W TM PFC: compliance with JEITA-MITI standard

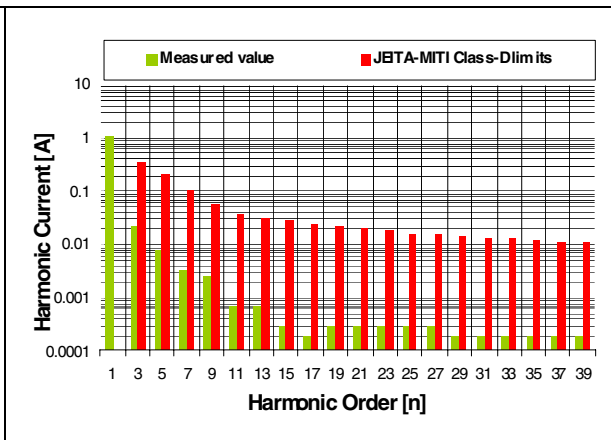


Figure 37. L6564 100 W TM PFC: input current waveform @230-50 Hz - 100 W load

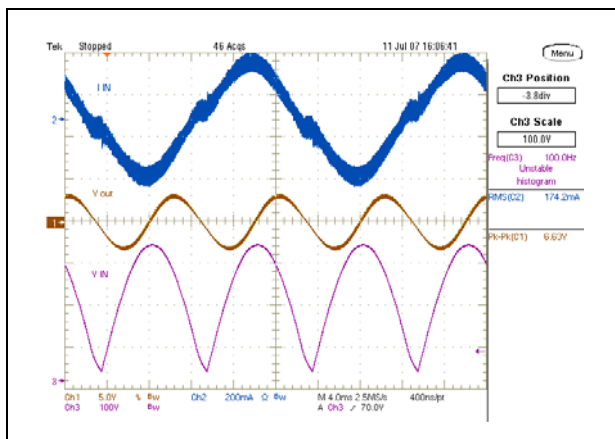
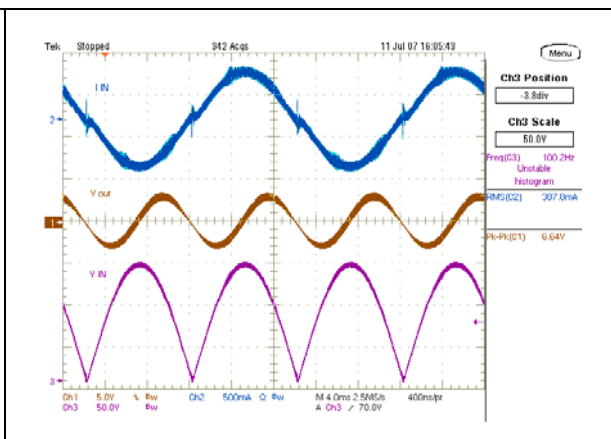


Figure 38. L6564 100W TM PFC: input current waveform @100 V-50 Hz - 100 W load



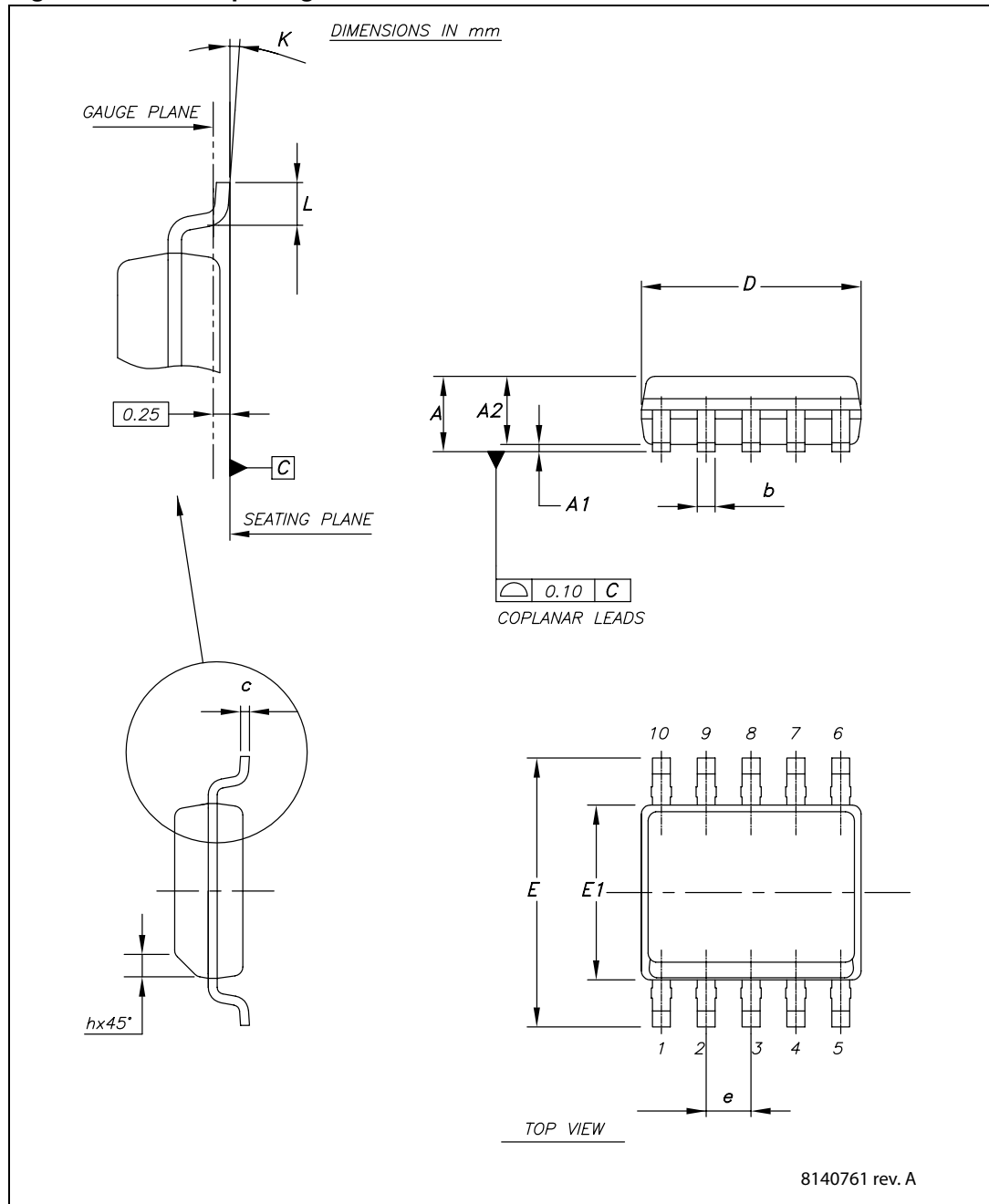
## 8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

**Table 6. SSO10 mechanical data**

Dim.	Databook (mm.)		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
c	0.17		0.25
D	4.80	4.90	5
E	5.80	6	6.20
E1	3.80	3.90	4
e		1	
h	0.25		0.50
L	0.40		0.90
K	0°		8°

Figure 39. SSO10 package dimensions



## 9 Ordering codes

Table 7. Ordering information

Order codes	Package	Packing
L6564TD	SSO10	Tube
L6564TDTR		Tape and reel

## 10 Revision history

**Table 8. Document revision history**

Date	Revision	Changes
18-Jan-2012	1	Initial release



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